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Nanoplatelets bridging a Nanotrench: a new architecture for photodetectors with increased sensitivity

Emmanuel Lhuillier^{1*}, Jean-Francois Dayen^{2*}, Daniel O. Thomas³, Adrien Robin,^{1,3} Bernard Doudin², Benoit Dubertret^{3*}

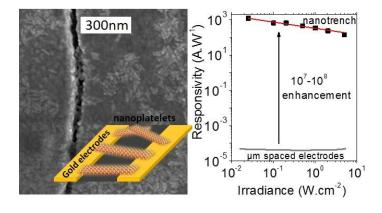
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Abstract: Inter-particle charge hopping severely limits the integration of colloidal nanocrystals films for optoelectronic device applications. We propose here to overcome this problem by using high aspect ratio interconnects made of wide electrodes separated by a few tens of namometers, a distance matching the single nanoplatelet size. The semiconducting CdSe/CdS nanoplatelet coupling with such electrodes allows an efficient electron-hole pair dissociation in spite of the large binding energy of the exciton, resulting in optimal photoconductance responsivity. We report the highest responsivity obtained so far for CdSe colloidal material with values reaching kA.W⁻¹, corresponding to 8 decades of enhancement compared to usual μm-scaled architectures. In addition, a decrease of one order of magnitude of the current noise is observed, revealing the reduced influence of the surface traps on transport. The nanotrench geometry provides top access to ion gel electrolyte gating, allowing for a photoresponsive transistor with 10⁴ on/off ratio. A simple analytical model reproduces the device behavior and underlines the key parameters related to its performance.

Keywords: semiconductor nanoparticles, quantum dot, nanoplatelets, photodetection, electrolyte gating, noise

TOC:



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1. INTRODUCTION

The implementation of colloidal quantum dots (QD) films in optoelectronic devices¹ is motivated by the ease of solution processing, their stability in oxygenated atmosphere and the easy process scalability, combined with the unique and tunable quantum nature of semiconductor nanoparticles. While the degree of control of intrinsic optical properties of isolated particles is remarkable, mastering the electrical and optoelectronic properties of a large ensemble of correlated constituents remains challenging. Charge transport in a QD film is a multiscale mechanism, where inter-grain hopping processes occur at the nanoparticle scale, while a percolative regime is predominant at larger scale, being directly influenced by the film morphology (cracks, electrostatic landscape...). Consequently, the interparticle tunnel barrier needs to be tuned and large scale ordering control is mandatory. Surface atomic passivation, such as S²⁻², SCN⁻³ or Cl⁻⁴ and metal chalcogenides ligands⁵, are well-documented techniques capable to shorten and lower the interparticle tunnel barrier, but they generally require the use of polar solvents. This comes at the price of limiting the methods usable to build or self-assemble the QD film, with a resulting limited long-range ordering in samples promoting percolating transport mechanisms detrimental to the device properties. In randomly packed films, the photoactivated carrier must perform a random walk before reaching the source and drain electrodes. This typically involves only a limited fraction of the sample for transferring the charges, with possibly several competing paths possible, both resulting in drastic loss of device performance. At a basic level, the intrinsic electronic properties of the QD get masked by the transport signature of the percolative processes. These drawbacks can be possibly overcome by a strategy taking advantage of hybrid structures, as illustrated by the use of QD-graphene hybrid⁶, where the absorption and hole-pair creation occurs in the QD, and the charge transfer occurs through the graphene intermediate. Another approach, allowing to keep the charge transport signature of the colloids, is the use of electrodes separated by a few nm only, electrically addressing a single nanoparticle⁷. In this particular situation, the short transport length also reduces the carriers transit time, which positively impacts the photoconductive gain of the device8,9. Several methods have been proposed to realize these nanogaps: e-beam lithography^{10,11}, self-alignment method^{12,13}, electromigration^{14,15}, to name a few. Making contact with a single nanoparticle provides unique insight into fundamental understanding and eliminates the complications associated with hopping-assisted percolating mechanism, but suffers from severe drawbacks. The first of these drawbacks is that room-temperature unique quantum properties of the dots imply sizes in the 10 nm scale, where electrodes fabrication reaches its limits of reliability, even when the most sophisticated lithography techniques are used. Secondly, the non-reproducibility from sample to sample in the electrode/nanoparticle interface requires statistical studies or scientifically-sound samples selection procedures. Finally, the poor effective light absorption due to the reduced active area and the lack of scalability of the proposed fabrication process severely limit the possible realization of devices relevant for applications. All these intrinsic difficulties make the development of new strategies mandatory for reliable and scalable device architectures. Alternatively, better-suited choices for QD geometries could greatly help their device integration. Of particular interest are nanoplatelets (NPL)^{16,17}, exhibiting a planar rectangular structure of a few atoms thick, providing a new class of nanomaterial with 2D quantum properties relevant for optoelectronic applications. We recently demonstrated that NPL are interesting candidates for photodetection and that their responsivity can be enhanced by 3 orders of magnitude while used in a phototransistor configuration interfacing several µm long NPL arrays¹⁸. In spite of these results, the overall response remains low and new strategies need to be developed. Here we propose to use a shadowing angle evaporation approach to create electrical interconnects separated by a short nanometric distance (typically 40-50 nm) over a very wide uniform length (typically 50 μm).¹⁹ The nanotrenches are ideally suited to electrically address a large ensemble of NPLs connected in parallel, with transport properties occurring over a length scale corresponding to the single particle size. This promotes the desired simplified and more efficient charge transfer mechanisms, free of hopping and percolation, ^{20,21} and at the same time offers a larger and more effective device area for optical detection.

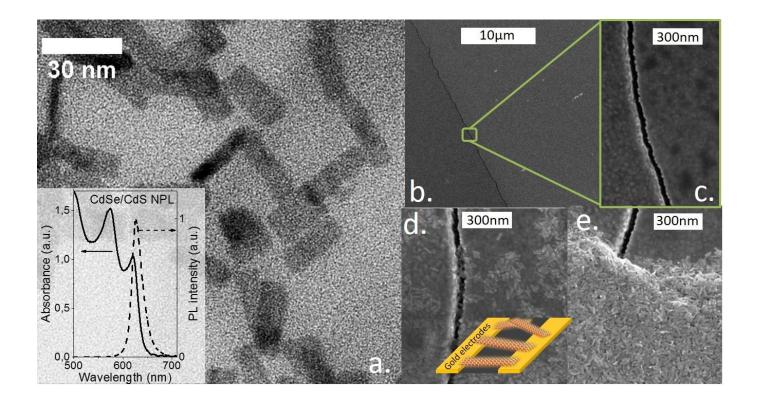


Figure 1 a TEM image of the NPL. The inset showsan Absorption and photoluminescence spectrum for CdSe/CdS NPL. For PL the NPL solution was excited at 350nm by a 150W xenon light with a 1nm slit. b-e are SEM images of naked nanotrenches (b-c) or decorated with low density (d) and high density (e) of NPL, the NPL appears as whitish rectangle. On d the inset is a scheme of the gold contact connected by the NPL.

We use CdSe/CdS NPL as colloidal nanocrystal material. The CdSe cores, synthetized following the procedure described in reference 17, correspond to a 2D sheet of 1.5nm thick with 10nm x 40nm lateral extension, (Figure 1a). We further grow a CdS shell using the C-ALD procedure, as proposed in 22. The NPL have a first excitonic feature at 630nm (2eV) attributed to the heavy hole-conduction band transition, while the second transition feature at 575nm results from the light hole conduction band transition¹⁷. See the supporting information for more information on the growth of nanoplatelets. Nanotrenches are fabricated through two steps of optical lithography combined with angle deposition ¹⁹ following a shadow-edge deposition strategy. It allows us to define a 40-50nm gap (see figures S1 and S2 of supplementary material), homogenously reproduced along several tens of μ m in between electrodes (μ 0 to 50 μ 1 in the present work, see Figure 1b-e and figure S2). The NPL capped by S²⁻ ligands² are then drop casted onto the nanotrench and annealed at 100°C to evaporate the solvent. Final devices are coated with a 200-300nm thick film of NPLs.

One of the key advantage of the nanotrench architecture is the possibility to apply fairly large electric field (F) over the structure (F>100kV.cm⁻¹). It makes it possible to measure a current under dark condition while no signal (i.e. below the setup resolution) was obtained when using standard μ m-spaced electrodes. A scheme of the experimental setup is given on figure S3 a and b. The signal is also strongly modulated while under illumination, see Figure 2a, with about 5 decades modulation with 50nW (\approx 5W.cm⁻²) illumination only. The photoresponse is fast with a bandwidth of

3 kHz, see Figure 2b and c . The system responsivity $R=rac{i_{photon}}{P_{light}}$ (ratio of the photocurrent i_{photon} over the incident

light into the nanogap P_{light} ²³) can reach the kA.W⁻¹order of magnitude, which corresponds to an external quantum efficiency $\eta g = \frac{hv.R}{e} = 3000$ electrons/photons (with $hv \approx 3$ eV the photon energy and e the proton charge), see

Figure 2d. Photoconduction data observed in the nanotrench geometry reveal an enhancement of almost 8 orders of

magnitude of the device responsivity, when compared to data obtained using μ m-spaced electrodes¹⁸ (showing values in the tens of μ A.W⁻¹ range, see Figure 2d) for the same NPL film preparation. A part of this improvement simply results from a geometrical effect, since a shorter channel comes with a short transit time and thus a high gain (defined as the ratio of the exciton lifetime over the transit time). Nevertheless, this effect only contributes for a factor of 200 (ratio of the channel length) to the increase of the responsivity. The additional increase observed can be explained by a combined effect of (i) the absence of cracks of defects in film at the scale of the nanotrench and (ii) an enhanced charge dissociation. Indeed, the measured sensitivity is one decade above the highest value reported for CdSe colloidal material²⁴ and compares to the best value obtained for PbS CQD²⁵. The high dielectric constant of PbS makes the exciton far easier to dissociate due to the poor bonding of the electron hole pair. In contrast, in CdSe and in particular in NPL, binding energy as high as $E_{binding}$ =250meV has been reported^{26,27}. Such strong coupling of the electron hole pair can contribute to the poor response obtained using μ m-spaced electrodes. The nanotrench architecture, because of the larger electric field F_{NPL} it can create along the NPL (F_{NPL} >100kV.cm⁻¹), provides a simple key to unlock this important technological bottleneck. Because of its nm spaced electrodes, the energy drop per particle F_{NPL} - with F_{NPL} the particle size -can easily overcome the NPL binding energy. This simply explains the significantly more efficient photocarrier separation observed in our devices.

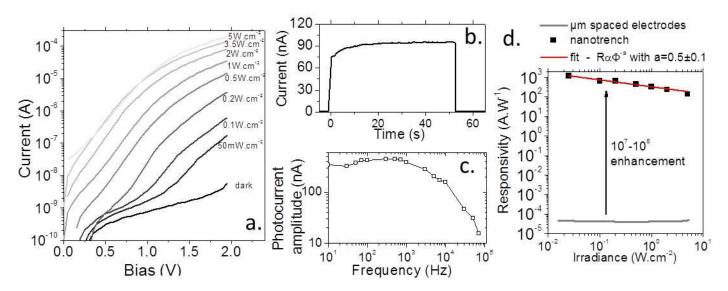


Figure 2a. Current as a function of the drain bias under dark and illuminated condition. b. Current as a function of time in response to a light illumination for a film of CdSe/CdS nanoplatelets under 1V drain bias and 1W.cm⁻² light power at 405nm). c Frequency dependence of the photocurrent, measured under 1V and 5mW.cm⁻² light illumination at 405nm. d Responsivity as a function of the irradiance for a film of CdSe nanoplatelets under a 2V bias illuminated by a laser at 405nm. The laser power varies from 0.25mW to 50mW.

The power dependence of the responsivity exhibits a power law behavior with an exponent equal to -0.5, see Figure 2d. According to the model described in reference 9, such dependence is typical of band gap recombination-limited devices and result from a higher band-to-band wavefunction overlap induced by the stark effect. This is in contrast to trap-limited systems exhibiting a photoresponse independent of incident power, as observed on Figure 2d for the µm spaced electrodes. In the nanotrench geometry, the transport is dominated by paths without traps. This speculation is consistent with the previously observed inhomogeneous photocurrent map over the nanotrench, see reference 8. The data of Figure 2d therefore strongly supports our hypothesis of charge transfer free of hopping in our devices.

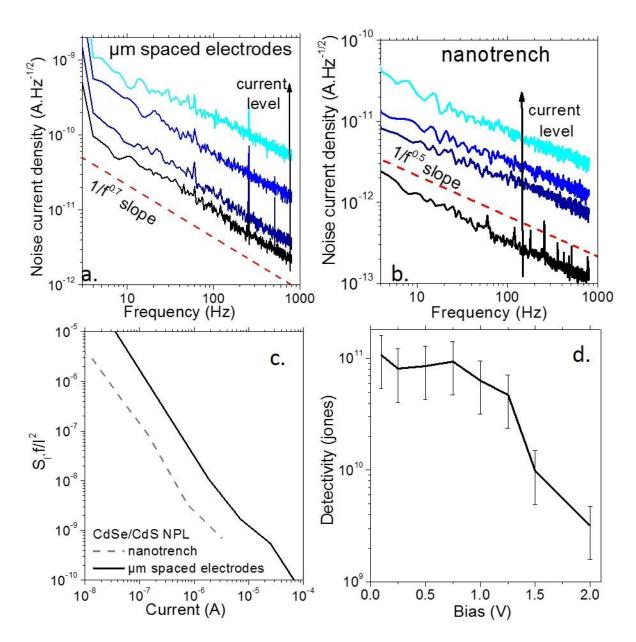


Figure 3 a. Noise as a function of frequency for a CdSe/CdS NPL film under different level of light irradiance connected over $10\mu m$ spaced interdigitated electrodes. B. Same as in a. for a 50nm spaced nanotrench. C. Relative noise (noise power density multiplied by the frequency -100Hz- and divided by the square of the current) as a function of the current for a film of CdSe/dS NPL connected over a nanotrench and over μm spaced electrodes. d. Detectivity of a CdSe/dS NPL film connected over a nanotrench, as a function of bias.

Electronic noise studies provide essential complementary information that validate the use of such devices for photodetection purposes. Noise measurements relate to the detectivity (signal to noise ratio), which is essential for the device performance figure of merit. There is a significant need of data on colloidal based devices, with studies usually limited to assumption that shot noise is prevailing, while detailed quantitative measurement of the noise spectrum is lacking. We are aware of a very few recent studies^{28,29} pointing out that the 1/f type of noise prevails in colloidal based devices, with a magnitude tunable over decades depending on the interparticle couductance²⁸. Here we argue that our proposed nanotrench geometry provides unique advantage for reducing the device current noise.

Further confirmation of the predominant intrinsic NPL transport signature is deduced from the current noise reduction, see figure S3 c for details about the experimental setup. The latter relates to the shrinking of the active electrical volume and to the change of transport mechanism when compared to macroscopic samples. Indeed it has been previously shown that hopping transport in a film of colloidal nanocrystals exhibits a strong 1/f noise signature^{28,29}. This is related to the mobility fluctuations due to variations of coupling from nanocrystals to nanocrystals. Such significant 1/f noise indeed prevails in our NPL films connected to μ m spaced electrodes, see Figure 3a. In this case, the current noise density presents a $1/f^{0.7}$ dependence. Flicker noise is also found on

nanotrench devices, see Figure 3b. However, the relative noise intensity (S_I/I^2) , with I the current and S_I the power noise current density is reduced by a decade with the nanotrench architecture, see Figure 3c. Again, in nanotrench architecture the carriers experience less NPL (mainly one single only) and are consequently less sensitive to the change of mobility coupling compared to the long percolating hopping path in μ m-spaced electrodes. From these

noise measurements we are able to evaluate the device detectivity $D^* = \frac{R\sqrt{A}}{i_n}$ with R the responsivity, A the

optical area and i_n the noise current density. We obtain value up to 10^{11} jones, see Figure 3d. The detectivity value is approximately constant up to 1V, and then drops as the current significantly increases because the applied bias over a particle starts to be of the order of half the material band edge energy. The value is currently limited by the small optical area inherent to the simple nanotrench geometry used here. Such limitation can easily be overcome by using several nanotrenches in a parallel geometry.

To further investigate the transport properties of the NPL/nanotrench hybrid, we gate the system using ion-gel electrolyte as proposed in ref 18 and 30. LiCLO₄ dissolved in polyethylelne glycol is used as electrolyte and a gold side gate is used to tune the Fermi level of the system. The gating is air operable. As expected for CdSe/CdS colloidal material we observe a n-type behavior, with a on/off ratio close to 4 decades, see Figure 4a.

To further understand the mechanism of transport involved in this short channel transistor we modeled the system band structure under the simplest hypothesis. The Poisson equation $\frac{d^2V}{dz^2} = -\frac{e^2N_D}{\varepsilon\varepsilon_D}$ with N_D the doping density, ε

the material dielectric constant, \mathcal{E}_0 the vacuum permittivity, leads to a parabolic bending of the band. From this equation we can expect a parabolic expression for the band profile in absence of applied electric field: $V(z) = az^2 + bz + c$. The boundary conditions are given at the interface by $V(0) = V(L) = V_s$ with V_s the interfacial potential and L the electrodes spacing bridged by a NPL. Assuming a Schottky contact we estimate V_s to be $V_s = \phi_M - \chi_{QD}$ where ϕ_M is the metal electrodes work function and χ_{QD} the QD electron affinity. The latter is itself related to the bulk electron affinity χ_{bulk} by $\chi_{QD} = \chi_{bulk} - E_c$ with E_c the confinement energy in the confinement band. A reasonable estimate of E_c is $E_c = \frac{m_v}{m_v} * (E_{QD} - E_{bulk})$ where m_v is the valence band

effective mass, m_c * the conduction band effective mass, E_{QD} the nanoparticle band edge energy and E_{bulk} the bulk band gap. The values of the whole set of parameters used for the modelling are given in table S1.

Moreover, we assume that in the middle of the nanotrench the Fermi level is in the middle of the gap (intrinsic behavior) which leads to $V(L/2) = E_{QD}/2 + \Delta E_F(V_{GS})$ with $\Delta E_F(V_{GS})$ the shift of the Fermi level related to the

gating. The use of this expression is reasonable if the depletion length given by $z_{dep} = \sqrt{\frac{2\varepsilon\varepsilon_0 k_{\scriptscriptstyle b} T}{e^2 N_{\scriptscriptstyle D}}}$ is significantly

shorter than the nanogap size. With ion-gel electrolyte, sheet density of 10^{14} cm⁻² are easily achieved³¹, corresponding to 10^{19} cm⁻³ as doping density for 100nm thick film. We can estimate that the depletion length is consequently just a few nm in our system, which remains a decade shorter than the channel size. We thus finally obtain, taking into account the applied electric field F between the drain source electrodes,

$$V(z) = \frac{4}{L^2} \left[E_{QD} / 2 + \Delta E_F (V_{GS}) - V_s \right] \left(z^2 - Lz \right) + V_s + eFz \qquad (1)$$

The parameters used for the modelling are given in table S1. The Figure 4b and figure S5 shows the obtained energy diagram using equation (1) under different drain and gate bias. Due to the gold electrodes used and the confinement in the NPL, we estimate that the Schottky barrier at the contact is of 0.5eV. In the intrinsic regime the bending of the band clearly undermines the electron injection.

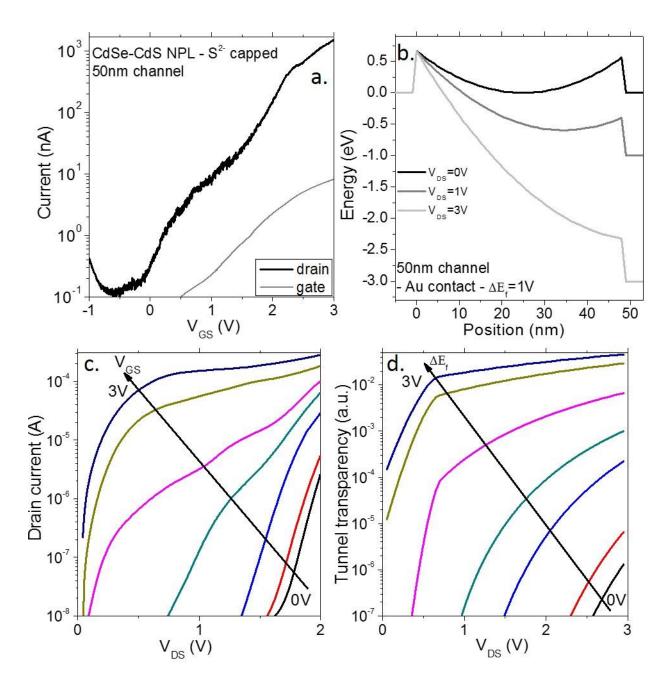


Figure 4 a. Drain current as a function of the gate voltage for a film of CdSe/CdS nanoplatelets bridging nanotrench electrodes spaced by a 50 nm gap. The drain current is set to 0.5V. b Scheme of the band structure based on equation (1) for a 1V displacement of the Fermi level and different drain source bias. c. Drain current as a function of the drain voltage for a film of CdSe/CdS nanoplatelets, under different gate bias (the step of gate bias is 0.5V). The drain bias is set to 0.5V. d. Tunnel transparency as a function of the applied bias over the nanotrench for different tunning of the Fermi level.

Then, to relate this band structure to the transport measurement we choose to evaluate the tunnel transparency of the contact. We use the Wentzel-Kramers-brillouin (WKB) approximation, for which the transparency is given by

$$T(E) = \exp\left(-2\sqrt{\frac{2m_c^*}{\hbar^2}}\int\limits_0^L\sqrt{V_C(z)-E}\,dz\right).$$
 The transport data (Figure 4c) are compared with the tunnel

transparency related to the Schottky contact barrier obtained by numerically integrating the conduction band profile (Figure 4d). This simplest modelling qualitatively reproduces the observed bias and gate dependence of the current.

We now discuss the expected transport mechanism to be promoted according to the tunnel transparency of the contact. At low gate bias, we reproduce the threshold aspect of the current related to the exponential dependence of the transparency with the electric field (introduced on Figure 5d, through the threshold gate voltage V_t). In this range of low gate bias, the transport is limited by the carrier injection and current only occurs when the potential

drop per particle overcomes at least half the energy gap E_G (with $E_G \approx 2eV$). The associated transport mechanisms are band-to-band tunneling (injection of electron from the valence band to the conduction band) and mid gap states assisted tunneling, see Figure 5c.

At higher gate bias we can distinguish two regimes. Below 0.5V of drain bias (roughly the height of the Schottky barrier) a strong bias dependence indicates that a significant part of the channel contributes to the tunnel barrier. In this range, the shift of the Fermi level may even lead to the formation of an electrostatically induced confined dot in the NPL and transport occurs over two steps of tunneling: one to enter the electrostatically confined area and one to leave it, see Figure 5a. On the other hand, for drain biases above the Schottky barrier, the bias dependence is significantly reduced, see Figure 4c, because the tunnel barrier is now sufficiently thin to ensure a good electron injection from the contact to the conduction band, see Figure 5b. A detailed description of the above-mentioned regimes are out of the scope of this paper, nevertheless it is clear from our modelling that for such nanotrench based devices the contacts are driving the transport properties and need to be efficiently engineered to ensure optimized device performances.

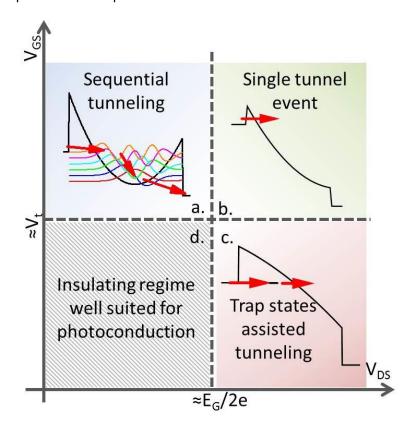


Figure 5 Phase diagram of the different transport processes as a function of drain and gate bias, respect to the energy gap E_G of the NPL and the threshold gate voltage V_t .

CONCLUSION

We investigate the transport and phototransport properties of colloidal nanoplatelets films connected over a nanotrench with inter-electrodes spacing matching the nanoplatelets length. In this configuration, we obtain significantly improved photodetection properties compared to usual µm-spaced electrodes with a photoresponse enhancement reaching 8 decades for a given material. In addition, this geometry reduces the influence of the traps and leads to a relative noise reduced by a decade. We also investigate the dark transport properties of the devices using an ion gel gating procedure. A simple analytical model illustrates the band structure under high electric field and a large shift of the Fermi level, which provides insight into observed I-V curves. Our model highlights the importance of the contact for devices whose channel length matches the contacted nanostructure size. More generally, combining nanoplatelets and nanotrench architecture presents itself as a unique device architecture to

develop a new family of detectors exploiting the unique properties of the physics of confined carriers in colloidal nanostructures.

Supplementary information

Additional informations include details about the chemical product and precursors, nanotrench fabrication, device characterization. This material is available free of charge *via* the Internet at http://pubs.acs.org.

Acknowledgements

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